# MGV2520102R2M-10

### PHYSICAL DIMENSIONS:

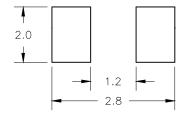
A  $2.50 \pm 0.20$ 

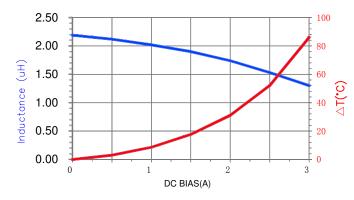
B  $2.00 \pm 0.20$ 

C 1.00 Max.

 $D = 0.60 \pm 0.30$ 

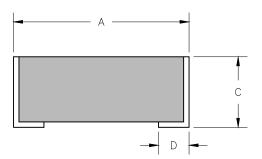
### LAND PATTERNS FOR REFLOW SOLDERING



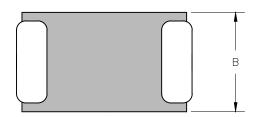


## ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	1.76	2.20	2.64
DCR $(\Omega)$		0.099	0.119
Saturation Current Isat (A)		2.40	2.16
Heating Current Irms (A)		2.30	2.07







#### NOTES:

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. OPERATING TEMPERATURE RANGE:  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ .
- 4. STORAGE TEMPERATURE RANGE:  $-40^{\circ}$ C  $\sim$   $+85^{\circ}$ C .
- 5. ISat MEANS THAT MAX DC CURRENT WILL CAUSE A PROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 6. Irms MEANS THAT MAX DC CURRENT WILL CAUSE PROXIMATELY 40°C TEMPERATURE RISE FROM 25±5°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird Tech. and is loaned in confidence					
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				PROJECT/PART NUMBER:	R	EV	PART TY	PE:	DRAWN BY:
				MGV2520102R2M-10		Α		OKE CTOR	QIU
				06/13/1/	SCALE	LE: NTS		SHEET:	
Α	ORIGINAL DRAFT	06/13/17	ä		TOOL		<u>.                                    </u>	4	- 6 4
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